

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
GOERTEK, INC.	07/23/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	WEIFANG GOERTEK MICROELECTRONICS CO., LTD.
<b>Street Address:</b>	BUILDING 10, GOER PHASE II INDUSTRIAL PARK NO. 102
<b>Internal Address:</b>	RONGHUA ROAD, RONGHUA COMMUNITY, XINCHENG SUB-DISTRICT OFFICE, HIGH-TECH DEVELOPMENT ZONE
<b>City:</b>	WEIFANG, SHANDONG PROVINCE
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 11</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16640015
Application Number:	16760816
Application Number:	16760803
Application Number:	16760540
Application Number:	16640022
Application Number:	16619980
Application Number:	16640009
Application Number:	16319525
Application Number:	13499948
Application Number:	13814559
Application Number:	14411651
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(212)408-2501
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>Correspondent Name:</b>	BAKER BOTTSCOM/PAUL A. RAGUSA
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<b>Address Line 4:</b>	NEW YORK, NEW YORK 10112
<b>ATTORNEY DOCKET NUMBER:</b>	087525.0124
<b>NAME OF SUBMITTER:</b>	PAUL A. RAGUSA
<b>SIGNATURE:</b>	/PAUL A. RAGUSA/
<b>DATE SIGNED:</b>	07/23/2020
<b>Total Attachments: 4</b> source=0124assign#page1.tif source=0124assign#page2.tif source=0124assign#page3.tif source=0124assign#page4.tif	

### ASSIGNMENT

This Assignment is made from the **Goertek, Inc.** (Assignor), having a place of business at 268 Dongfang Road, Hi-Tech Industry District, Weifang City, Shandong, 261031, China to **Weifang Goertek Microelectronics Co., Ltd.** (Assignee), having a place of business at Building 10, Goer Phase II Industrial Park, No. 102, Ronghua Road, Ronghua Community, Xincheng Sub-district Office, High-Tech Development Zone, Weifang, Shandong Province, China.

WHEREAS, Assignor is an owner of the inventions in **Table A**;

WHEREAS, Assignor desires to have a recordable instrument assigning its entire right, title and interest in and to said inventions, said applications and any Letters Patent that may be granted for said inventions in the United States and throughout the world to Assignee;

NOW THEREFORE, in accordance with the obligations to assign the inventions and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignor sells, assigns, and transfers to Assignee, its entire right, title, and interest in and to said inventions, said application and any Letters Patent that may be granted for said inventions in the United states and throughout the world, including the right to file foreign applications directly in the name of Assignee and to claim for any such foreign applications any priority rights to which such applications are entitled under international conventions, treaties, or otherwise.

Assignor agrees that, upon request and without further compensation, but at no expense to Assignor, its legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing Letters Patent in the United states and throughout the world for said invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said invention, said application, and any Letters Patent granted for said invention in the United States and throughout the world.

Assignor represents and warrants that it has not granted and will not grant to others any rights inconsistent with the rights granted herein.

Assignor authorizes and requests the Commissioner of Patents and Trademarks of the United States and of all foreign countries to issue any Letters Patent granted for said inventions, whether on said applications or on any subsequently filed division, continuation, continuation-in-part or reissue application, to Assignee, its successors and assigns, as the assignee of its entire interest in said inventions.

IN WITNESS WHEREOF, Assignor has executed this Assignment on the date(s) provided below.

**GOERTEK, INC.**

Date: 2020.07.13 Bin Jiang

Witnessed by: Name Ying Zhang  
Please Print or Type Name

Signature: Ying Zhang

WEIFANG GOERTEK MICROELECTRONICS CO., LTD.

Date: 2020.7.23      Long Jiang

Witnessed by: Name Ying Zhang  
Please Print or Type Name

Signature: Ying Zhang

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**TABLE A**

Application No.
US16/640015
US16/760816
US16/760803
US16/760540
US16/640022
US16/619980
US16/640009
US16/319525
US13/499948
US13/814559
US14/411651